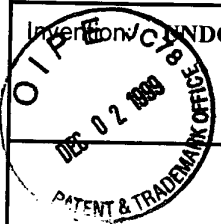


CAU 1765

AMENDMENT TRANSMITTAL LETTER (Large Entity)			Docket No. 11675.114
Applicant(s): Kei-Yu Ko			
Serial No. 08/846,671	Filing Date April 30, 1997	Examiner Goudreau	Group Art Unit 1765



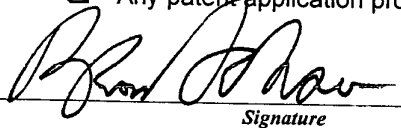
Inventor: UNDOPED SILICON DIOXIDE AS ETCH STOP FOR SELECTIVE ETCH OF DOPED SILICON DIOXIDE

TO THE ASSISTANT COMMISSIONER FOR PATENTS:

Transmitted herewith is an amendment in the above-identified application.
The fee has been calculated and is transmitted as shown below.

CLAIMS AS AMENDED					
	CLAIMS REMAINING AFTER AMENDMENT	HIGHEST # PREV. PAID FOR	NUMBER EXTRA CLAIMS PRESENT	RATE	ADDITIONAL FEE
TOTAL CLAIMS	51 -	54 =	0 x	\$18.00	\$0.00
INDEP. CLAIMS	7 -	8 =	0 x	\$78.00	\$0.00
Multiple Dependent Claims (check if applicable) <input type="checkbox"/>					\$0.00
TOTAL ADDITIONAL FEE FOR THIS AMENDMENT					\$0.00

- ☒ No additional fee is required for amendment.
- ☐ Please charge Deposit Account No. _____ in the amount of _____
A duplicate copy of this sheet is enclosed.
- ☐ A check in the amount of _____ to cover the filing fee is enclosed.
- ☒ The Commissioner is hereby authorized to charge payment of the following fees associated with this communication or credit any overpayment to Deposit Account No. 23-3178
A duplicate copy of this sheet is enclosed.
 - ☒ Any additional filing fees required under 37 C.F.R. 1.16.
 - ☒ Any patent application processing fees under 37 CFR 1.17.



Signature

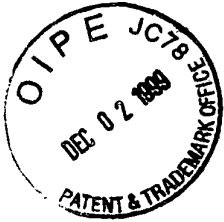
Dated: November 24, 1999

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cc:

I certify that this document and fee is being deposited on Nov. 24, 1999 with the U.S. Postal Service as first class mail under 37 C.F.R. 1.8 and is addressed to the Assistant Commissioner for Patents, Washington, D.C. 20231.	
	
Signature of Person Mailing Correspondence	
Peggy R. Huft	
Typed or Printed Name of Person Mailing Correspondence	



PATENT APPLICATION
Docket No: 11675.114

#5/A
4a
12/8/99

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:

Kei-Yu Ko

Serial No.: 08/846,671

Filed: April 30, 1997

For: **UNDOPED SILICON DIOXIDE AS
ETCH STOP FOR SELECTIVE ETCH
OF DOPED SILICON DIOXIDE**

Examiner: George A. Goudreau

Unit 176

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**AMENDMENT "A" AND ELECTION IN RESPONSE TO
RESTRICTION REQUIREMENT**

Honorable Commissioner of Patents
and Trademarks
Washington, D.C. 20231

Sir:

IN THE CLAIMS:

Please cancel Claims 47-49 without prejudice to the filing of a divisional patent application.